IPC ASSOCIATION ELECTRONIC	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved und international and Pan-American copyright conventions.			der both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
1752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					rials and M	ials and Mfg Information			
Supplie	r Information														
Company name* Company unique ID				ique ID	Unique		Unique ID Au	que ID Authority			Respons	Response Date*			
nsemi											2024-05	2024-05-21			
Contact N	ame	Title - Contact			1	Phone - Contact*				Email - Contact*					
Product-l	Env-Stewards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Authorized Representative* Ti				Title - Representative			Phone - Representative*				Email -	Email - Representative*			
Product-Env-Stewards Pro				Product Enviro Compliance			NA				Produc	Product-Env-Stewards@onsemi.com			
	Requester Item Number Mfr Item		Number Mfr Item Name				Effective Dat	e Date Version Manufacturing Site			Weight*	UOM	Unit Type		
		NC7SZU04M5X Single Unbufrd Inv		erter		2024-05-21	5-21 CN1			15.867101	mg	Each			
Aanufa	cturing Process Informa	ation						•						·	
	Terminal Plating / Grid Array Material Terminal Base Alloy J-STD-020 M				STD-020 MS							eles			
Matte Tin (Sn) - annealed CU Alloy 1					260		C	30	secon	ds 3					
Comments	S														
vel 1 - m	aximum time at peak temperat	ture during sol	dering is 10-3	30 seconds											
or more	information regarding materia	l composition	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information is true and corrections that such information is true and corrections that such information is true and corrections that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Clip	8.78733	mg	Supplier	Zinc (Zn)	7440-66-6		0.0105	mg
			Supplier	Iron (Fe)	7439-89-6		0.2065	mg
			Supplier	Copper (Cu)	7440-50-8		8.5676	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0026	mg
Die	0.8101	mg	Supplier	Silicon (Si)	7440-21-3		0.8101	mg
Die Attach	0.1013	mg	Supplier	Silver (Ag)	7440-22-4		0.081	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.0203	mg
Mold Compound-Black	6.0046	mg		Epoxy resin	proprietary data		0.3002	mg
			Supplier	Phenolic Resin	Proprietary Data		0.1201	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.1501	mg
			Supplier	Carbon Black (C)	1333-86-4		0.03	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		5.4041	mg
Plating	0.062571	mg	Supplier	Palladium (Pd)	7440-05-3		0.0027	mg
			В	Nickel (Ni)	7440-02-0		0.059	mg
			Supplier	Gold (Au)	7440-57-5		0.0009	mg
Wire Bond - Au	0.1012	mg	Supplier	Gold (Au)	7440-57-5		0.1012	mg